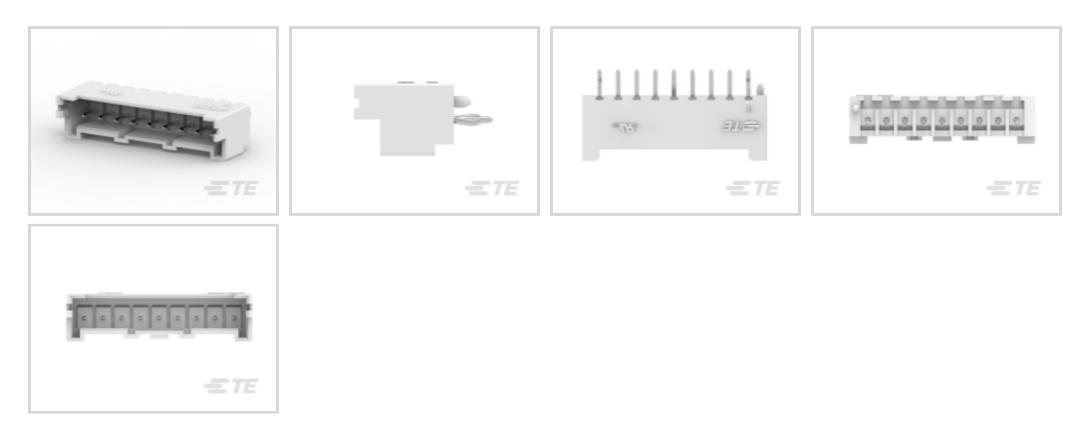


Economy Power 2.5

TE Internal #: 1969730-9 PCB Mount Header, Vertical, Wire-to-Board, 9 Position, 2.5 mm [. 098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Economy Power 2.5

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 9

Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]

PCB Mount Orientation: Vertical

Features

Connectivity

Product Type Features

Connector System	Wire-to-Board	
Header Type	Fully Shrouded	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
PCB Connector Assembly Type	PCB Mount Header	
Configuration Features		
Number of Positions	9	
Number of Rows	1	
PCB Mount Orientation	Vertical	
Body Features		
Primary Product Color	Natural	
Contact Features		
Mating Pin Diameter	.6 mm[.024 in]	
Contact Mating Area Plating Material Thickness	2 – 5 µm[80 – 200 µin]	

PCB Mount Header, Vertical, Wire-to-Board, 9 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Economy Power 2.5



Contact Mating Area Plating Material Finish	Bright
Contact Underplating Material	Nickel
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	4.2 A
Termination Features	
Round Termination Post & Tail Diameter	.6 mm[.024 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Alignment Type	Locating Posts
Mating Alignment Type	Polarization
Mating Retention	With
PCB Mount Retention Type	Boardlock

Connector Mounting Type

Mating Alignment

PCB Mount Alignment

PCB Mount Retention

With

With

With

Housing Features

Housing Material	PBT GF	
Centerline (Pitch)	2.5 mm[.098 in]	
Dimensions		
Connector Length	22 mm[.86 in]	
PCB Thickness (Recommended)	1.6 mm[.063 in]	
Usage Conditions		
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]	
Operation/Application		
Circuit Application	Power & Signal	
Industry Standards		
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Type	Bag, Box	

PCB Mount Header, Vertical, Wire-to-Board, 9 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Economy Power 2.5



Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Not reviewed for solder process capability

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Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



PCB Mount Header, Vertical, Wire-to-Board, 9 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Economy Power 2.5

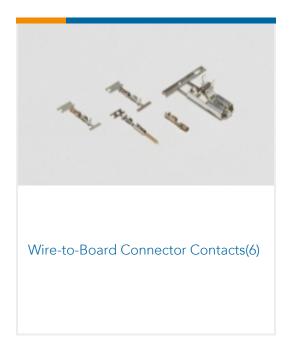




Also in the Series | Economy Power 2.5



PCB Headers & Receptacles(494)	PCB Latches, Locks & Retainers(49)	Rectangular Power Connectors(43)	Wire-to-Board Connector Assemblies
			& Housings(311)



Customers Also Bought



PCB Mount Header, Vertical, Wire-to-Board, 9 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Economy Power 2.5





Documents

Product Drawings EP2.5 SHROUDED HDR ASSY 9P VERTICAL

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1969730-9_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1969730-9_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1969730-9_A.3d_stp.zip

English

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Product Specifications Application Specification

English

Product Environmental Compliance

MD_1969730-9_06212017647_dmtec

English

MD_1969730-9_06212017647_dmtec

English

Agency Approvals

UL Report

English